

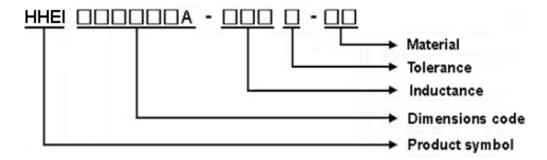
ISO9001 & ISO14001 & TS16949 CHILISIN ELECTRONICS CORP.

RoHS & Halogen Free & REACH Compliance.

SPECIFICATION FOR APPROVAL

Customer:		
Customer P/N:		
Drawing No:		
Quantity:	X Pcs. DATE:	2016/08/17
Chilisin P/N:	HHEI252010A-	1R0M-Q8
		_
	SPECIFICATION	
	ACCEPTED BY:	
COMPONENT		
ENGINEER		
ELECTRICAL		
ENGINEER MECHANICAL		
ENGINEER		
APPROVED		
REJECTED		
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奇力新電子(河南)有限公 Chilisin Electronics (Henan) Co XiuWu Xian, industry gathering JiaoZuo, Henan China Postal Code:454350 TEL:+86-391-717-0682 FAX:+86-391-717-0666	D., Ltd. SUZHOU QI YIXIN E	Electronics Co., Ltd. Rd., Suzhou New District, 2350 2356
Drawn by 張鈺雯 chang.yuwen	Checked by 張鈺雯 chang.yuwen	Approved by 鍾瑞民 jacky.chung

- 1 Scope: This specification applies to Molding power inductors
- 2 Part Numbering:



3 Rating:

Operating Temperature: $-4.0 \,^{\circ}\text{C} \sim 1.2.5 \,^{\circ}\text{C}$ (Including self - temperature rise)

Storage Temperature: $-4.0 \,^{\circ}\text{C} \sim 1.2.5 \,^{\circ}\text{C}$ (after PCB)

 $-5\,^\circ\text{C}\sim3\,\,5\,^\circ\text{C}$, Humidity $4\,\,5\,\%\sim8\,\,5\,\%$ (before PCB)

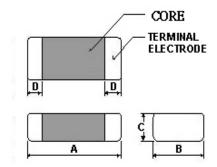
4 Marking:

No Marking

5 Standard Testing Condition

	Unless otherwise specified	In case of doubt
Temperature	Ordinary Temperature(15 to 35°ℂ)	20 to 30°C
Humidity	Ordinary Humidity(25 to 85% RH)	50 to 80 %RH

6 Configuration and Dimensions:



Dimensions in mm

TYPE	HHEI252010A
Α	2.5±0.3
В	2.0±0.3
С	1.0max
D	0.6±0.3

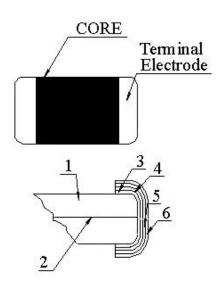
7 ELECTRICAL CHARACTERISTICS :

Part No.	Inductance (uH)	Tolerance (±%)	Test Freq.	Irms(A) Max.(Typ)	Isat(A) Max.(Typ)	RDC(mΩ) Max.(Typ)	
HHEI252010A-1R0M-Q8	1.0	20	2MHz,0.2V	4.2(4.4)	4.7(5.0)	30(25)	

NOTE:

- 1.Operating temperature range $-4~0~\mathrm{^{\circ}C} \sim 1~2~5~\mathrm{^{\circ}C}$ (Including self temperature rise)
- 2.ldc: DC current (A) that will cause an approximate ΔT of 40°C.
- 3.Isat: DC current (A) that will cause Lo to drop approximately 30%
- 5. Absolute maximum voltage 25 VDC

8 HHEI252010A Series 8.1 Construction:



8.2 Material List:

No	Part	Material
1	Core	Metal Powder
2	Wire	Copper wire
3	Sputter/Plating	Cu
4	Silver Electrode	Ag
5	Plating	Ni
6	Plating	Sn



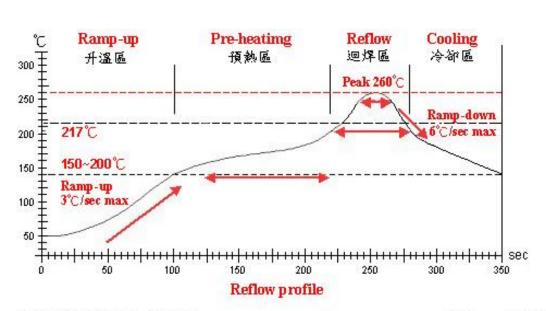
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HHEI252010A Series Specification 9 Reliability Of Molding power inductors

1-1.Mechanical Performance

No	Item	Specification	Test Method
1-1-1	Flexure Strength	The forces applied on the right	Test device shall be soldered on the substrate
		conditions must not damage	Substrate Dimension: 100x40x1.6mm
		the terminal electrode and the	Deflection: 2.0mm
		metal body	Keeping Time: 30sec
1-1-2	Vibration	Appearance:No damage (for	Test device shall be soldered on the substrate
		microscope of CASTOR MZ-45 20X)	Oscillation Frequency: 10 to 55 to 10Hz for 1min
		Inductance change shall be	Amplitude: 1.5mm
		within ±20%	Time: 2hrs for each axis (X, Y & Z), total 6hrs
1-1-3	Resistance to Soldering Heat	Appearance: No damage	Pre-heating: 150°C, 1min
		More than 75% of the terminal.	Solder Composition: Sn/Ag3.0/Cu0.5(Pb-Free)
		electrode should be covered	Solder Temperature: 260±5°C
		with solder.	Immersion Time: 10±1sec
		Inductance: within ±20% of	
		initial value	
1-1-4	Solder ability	The electrodes shall be at	Pre-heating: 150°C, 1min
		least 95% covered with new	Solder Composition: Sn/Ag3.0/Cu0.5(Pb-Free)
		solder coating	Solder Temperature: 245±5°ℂ
		-	Immersion Time: 4±1sec
1-1-5	Terminal Strength Test	No split termination	Test device shall be soldered on the substrate,
		Chip	then apply a force in the direction of the arrow.
			Force : 5N
		F	Keeping Time: 10±1sec
		Mounting Pad	

No	Item	Specification		Test Method		
1-2-1	Temperature Cycle	Appearance: No damage	One cycle:			
		Inductance:within±20% of	Step	Temperature (°ℂ)	Time (min)	
		initial value	1	-40±3	30	
			2	25±2	3	
			3	125±3	30	
			4	25±2	3	
			Total: 100d	cycles		
			Measured	after exposure in the room co	ondition for 24hrs	
1-2-2	Humidity Resistance		Temperatu	ıre: 60±2°C		
			Relative Humidity: 90 ~ 95% / Time: 500hrs			
			Measured	after exposure in the room co	ondition for 24hrs	
1-2-3	High		Temperatu	ıre: 85±3°C		
	Temperature Resistance		Relative H	umidity: 0% / Time: 500hrs		
			Measured after exposure in the room condition for 24hrs			
1-2-4	Low		Temperature: -40±3°C			
	Temperature Resistance		Relative Humidity: 0% / Time: 500hrs			
			Measured after exposure in the room condition for 24hi			



Lead-Free(LF) 標準溫度分析範圍

Refer to J-STD-020C

管制項目 Item.	升溫區 Ramp-up	預熱區 Pre-heatimg	迴焊區 Reflow	Peak Temp	冷卻區 Cooling
溫度範圍 Temp.scope	R.T. ~150°℃	150℃ ~ 200℃	217℃	260±5°ℂ	Peak Temp. ~ 150°C
標準時間 Time spec.	_	60 ~ 180 sec	60 ~ 150 sec	20 ~ 40 sec	2 2
實際時間 Time result		75 ~ 100 sec	90 ~ 120 sec	20 ~ 35 sec	1 1

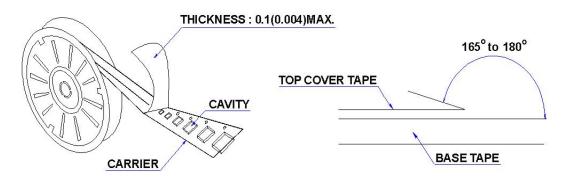
NOTE:

- 1. Re-flow possible times: within 2 times
- 2. Nitrogen adopted is recommended while in re-flow

10 Packaging

10.1 Packaging -Cover tape

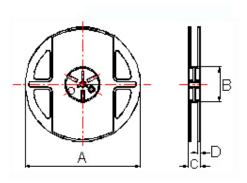
The force for tearing off cover tape is 10 to 100 grams in the arrow direction.



10.2 Packaging Quantity

TYPE	PCS/REEL	
HHEI252010A	3000	

10.3 Reel Dimensions



Dimensions in mm

TYPE	Α	В	С	D
HHEI252010A	178	60	12	1.5

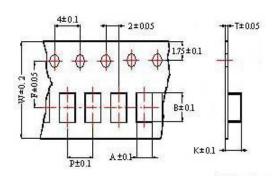


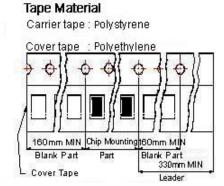
CHILISIN ELECTRONICS CORP.

HHEI252010A Series Specification

10 Packaging

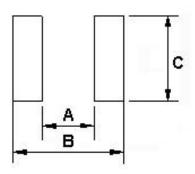
10.4 Tape Dimensions in mm





TYPE	А	В	Т	W	Р	F	K
HHEI252010A	2.25	2.80	0.22	8	4	3.5	1.15

11 Recommended Pattern



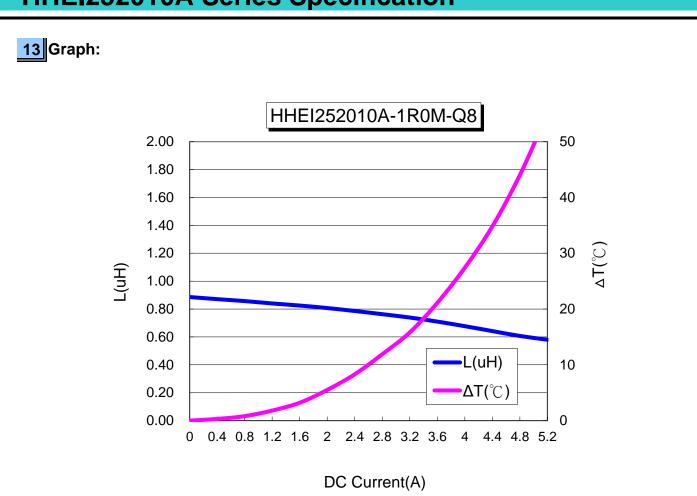
Dimensions in mm

TYPE	А	В	С
HHEI252010A	1.2	2.8	2.3

12 Note:

- 1. Please make sure that your product has been evaluated and confirmed against your specifications when our product is mounted to your product.
- 2. Do not knock nor drop.
- 3. All the items and parameters in this product specification have been prescribed on the premise that our product is used for the purpose,under the condition and in the environment agreed upon between you and us. You are requested not to use our product deviating from such agreement.
- 4. Please keep the distance between transformer/coil and other components (refer to the standard IEC 950)
- 5.After manufacturing process, there might be slight irregular shape on the edge of the products, and it's a normal phenomenon that can be neglected
- 6. The moisture sensitivity level (MSL) of products is classified as level 1.





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